

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:70%;">Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Ralf LERNER</td> <td>12/08/2005</td> </tr> <tr> <td>Uwe ECKOLDT</td> <td>12/08/2005</td> </tr> </tbody> </table>		Name	Execution Date	Ralf LERNER	12/08/2005	Uwe ECKOLDT	12/08/2005
Name	Execution Date						
Ralf LERNER	12/08/2005						
Uwe ECKOLDT	12/08/2005						
RECEIVING PARTY DATA							
Name:	X-Fab Semiconductor Foundries AG						
Street Address:	Haarbergstrasse 67						
City:	Erfurt						
State/Country:	GERMANY						
Postal Code:	99097						
PROPERTY NUMBERS Total: 1							
<table border="1" style="width:100%; border-collapse: collapse;"> <thead> <tr> <th style="width:30%;">Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>10530343</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	10530343		
Property Type	Number						
Application Number:	10530343						
CORRESPONDENCE DATA							
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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NAME OF SUBMITTER:	Daniel G. Vivarelli, Jr.						
Total Attachments: 2 source=DOC002#page1.tif source=DOC002#page2.tif							

CH \$40.00 10530343

**RECORDATION FORM COVER SHEET
PATENTS ONLY**

To the Director of the U.S. Patent and Trademark Office: Please record the attached document(s) or new address(es) below.

1. Name of Conveying Party(ies):

Ralf LERNER
Uwe ECKOLDT

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and Address of Receiving Party(ies):

Name:	X-Fab Semiconductor Foundries AG	Name:	
Address:	Haarbergstrasse 67 99097 Erfurt	Address:	

Country: GERMANY Country: Yes No
Additional name(s) and address(es) attached? Yes No

3. Nature of Conveyance/Execution Date(s):

Execution Date(s) December 8, 2005

- | | |
|---------------------------------------------------------------------|-----------------------------------------|
| <input checked="" type="checkbox"/> Assignment | <input type="checkbox"/> Merger |
| <input type="checkbox"/> Security Agreement | <input type="checkbox"/> Change of Name |
| <input type="checkbox"/> Joint Research Agreement | |
| <input type="checkbox"/> Government Interest Assignment | |
| <input type="checkbox"/> Executive Order 9424, Confirmatory License | |
| <input type="checkbox"/> Other: _____ | |

4. Application or Patent Number(s): This document is being filed together with a new application.

A. Patent Application No.(s): 10/530,343
B. Patent No.(s):

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Jennifer A. Albert, Esq.
Intellectual Property Department
Hunton & Williams LLP
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CUSTOMER NO. 21967

6. Total number of applications and patents involved:

Application(s): 1
+ Patent(s): _____
= Total: 1

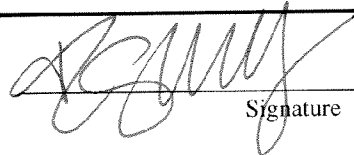
7. Total Fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged to Deposit Account 50-0206
 Enclosed
 None required (government interest not affecting title)

8. Payment Information

Deposit Account No.: 50-0206
 Charge any underpayment or credit any overpayment to above Deposit Account

9. Signature:


Signature

May 19, 2006
Date

Daniel G. Vivarelli, Jr.
Name of Person Signing

Total number of pages including cover sheet, attachments, and document:

2

Confirmatory assignment

Ralf LERNER

Josef-Albers-Strasse 20
99085 Erfurt, Germany

and

Uwe ECKOLDT

Im Dorfe 60
99448 Hohenfelden, Germany

have invented

"Trench Isolation in Substrate Wafers including Logic
Semiconductor Devices and Power Semiconductor Devices"

for which PCT application PCT/DE2003/003332 was filed on October 8, 2003
continued in USA as 10/530,343.

By way of "claiming" the inventors have transferred said invention under German
law of inventors, Section 9 ArbNErfG to the assignee

X-Fab Semiconductor Foundries AG

Haarbergstrasse 67
99097 Erfurt, Germany

The inventors have acquired a right of monetary compensation under
Section 9,12 ArbNErfG.

We do hereby authorize and request the Director of the United States Patent and
Trademark Office to issue any and all letters patent which may be granted upon
said United States applications, or upon said improvements or any parts thereof
when granted, to said Assignee.

In Witness whereof, we have hereunto set our hand and seal.

12.8.05
Date


Ralf Lerner

12.8.05
Date


Uwe Eckoldt